



Higher Education Loans and Scholarships Board (HELSB)

ANNOUNCEMENT: 2026 KOICA SCHOLARSHIP PROGRAMME Republic of Korea

The Higher Education Loans and Scholarships Board (HELSB) hereby invites applications for the 2026 KOICA Scholarship Programme, pursuant to official notification from the Embassy of the Republic of Korea to the Government of the Republic of Zambia.

LEVEL & PROGRAMMES

Master's Degree Programs Available:

- Ewha Women's University – Master's in Gender Equality
- Hanyang University – Master's in Smart-City Management and Technology
- Korea National University of Education – Master's in Global Education Leadership
- Korea University – Master's in Tax and Fiscal Policy
- Seoul National University – Master's in Public Management and Administrative Reform

(Doctoral degree programs are available as outlined in the official KOICA guidelines.)

SCHOLARSHIP COVERAGE

The scholarship provides full support for successful candidates, including:

- Tuition fees
- International travel
- Basic living allowance
- Medical insurance

ELIGIBILITY CRITERIA

Applicants must:

- Be Zambian Government officials or public sector employees
- Hold a Bachelor's degree or higher
- Be not more than forty (40) years of age at the time of application
- Satisfy all academic and professional requirements prescribed by KOICA

Final selection is competitive and conducted by KOICA in collaboration with partner universities.

APPLICATION PROCEDURE

- Download and complete the official KOICA Application Form from official website; www.koica.go.kr/sites/ciat/index.do
- Applications must not be submitted directly to KOICA
- Applications shall be submitted to HELSB only after official nomination by the Government of Zambia or an authorized nominating institution
- All required supporting documents as indicated on the official KOICA website must be submitted to HELSB

IMPORTANT DEADLINE

Final Application Deadline:

24 December 2025

(Late submissions will not be accepted.)

Applications should be addressed to:

The Chief Executive Officer
Higher Education Loans and Scholarships Board
P.O. Box 320298,
LUSAKA

Or Hand delivered to:

The Reception
Higher Education Loans and Scholarships Board
2nd Floor United Church House,
No. 8 Mosi-oo- Tunya Road,
Woodlands,
LUSAKA

OR

The Higher Education Loans and Scholarships Board,
C4 Copperbelt University Riverside Campus,

KITWE

OR

The Higher Education Loans and Scholarships Board,
Mulungushi University, P.O Box 80415, Town campus,

KABWE

OR

The Higher Education Loans and Scholarships Board,
Stand No 6711, Mberere Road Olympia Park Extension

LUSAKA

Dr. John Machayi

Chief Executive Officer

Higher Education Loans and Scholarships Board (HELSB)